IPC ASSOCIATION ELECTRONIC	© Copyright 2005	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1					Form Type * Distribute	e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					eous Materia	als and Mf	g Informat	tion	
upplier	Information								·						
Company	name*	Company unique ID			Ţ	Unique ID Authority					Response Date*				
nsemi												2025-07-16			
Contact N	ame	Title - Contact			F	Phone - Contact*					Email - Contact*				
Product-I	Env-Stewards		Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com				
uthorize	d Representative*		Title - Representative			F	Phone - Representative*				Email - Representative*				
Product-I	Env-Stewards		Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr Item		m Number Mfr Item Name				Effective Date	Versio	Tersion Manufacturing S		ring Site	Weight*		UOM	Unit Type
		NSS40500UW3T2G WDI		WDFN3 2*2 LOW VCE(SAT) TR		1	2025-07-16		N	MY1		9	.63	mg	Each
Ianufa	cturing Process Inform						la								
	8		, and the second		-STD-020 MSL	Rating			Body Temperature Max Time at Peak		1		ber of Reflow Cyc	eles	
	Matte Tin (Sn) - annealed		CU Alloy	1			260		C	30		second	ls 3		
omments															
	aximum time at peak temper														
or more	information regarding mater	ial composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its uppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.36	mg	Supplier	Silicon (Si)	7440-21-3		0.36	mg
Die Attach	0.14	mg	Supplier	Silver (Ag)	7440-22-4		0.119	mg
			Supplier	Epoxy resins	129915-35-1		0.021	mg
Lead Frame	2.69		Supplier	Silver (Ag)	7440-22-4		0.0538	mg
			Supplier	Iron (Fe)	7439-89-6		0.0592	mg
			Supplier	Copper (Cu)	7440-50-8		2.577	mg
Mold Compound-Black	5.8	mg		Epoxy Phenol Resin	proprietary data		0.522	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		5.278	mg
Plating	0.57	mg	Supplier	Tin (Sn)	7440-31-5		0.57	mg
Wire Bond - Cu	0.07	mg	Supplier	Copper (Cu)	7440-50-8		0.07	mg